Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	6903939	"20040185639" A1	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR .	ON	2007/08/29 08:04
L2	2	"20040185639"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 08:04
L4	34	"5414297"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 10:14
L5	9	"6007650"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 10:22
L6	10	"4818323"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 10:23
S1	2825	438/455.ccls. or 438/458.ccls. or 438/459.ccls. or 438/460.ccls. or 438/464.ccls. or 438/465. ccls.	USPAT	OR	ON	2007/08/27 15:44
S2	1852	438/455.ccls. or 438/458.ccls. or 438/459.ccls.	USPAT	OR	ON	2007/08/27 15:43
S3	1242	438/460.ccls. or 438/464.ccls. or 438/465.ccls.	USPAT	OR	ON	2007/08/27 15:44
S4	1583	S2 not S3	USPAT	OR	ON	2007/08/27 15:44
S5	1784	S1 and ((grind\$3 or thin\$4) with (wafer or substrate))	USPAT	OR	ON	2007/08/27 15:45
S7	1327	S2 and ((dic\$3 or cut\$4 or separat\$3) with (wafer or substrate))	USPAT	OR	ON	2007/08/27 15:54
S8	124	S3 and ((resin or adhesive or glue) with light)	USPAT	OR	ON	2007/08/27 15:51

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S9	690	S3 and (irradiat\$3 or radiat\$3 or photothermal or UV or light or energy)	USPAT	OR	ON	2007/08/27 15:52
S10	64559	((grind\$3 or thin\$4) with wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 15:49
S11	1482	S5 and ((dic\$3 or cut\$4 or separat\$3) with (wafer or substrate))	USPAT	OR	ON	2007/08/27 15:50
S12	127	S7 and ((resin or adhesive or glue) with light)	USPAT	OR	ON	2007/08/27 15:52
S13	944	S7 and (irradiat\$3 or radiat\$3 or photothermal or UV or light or energy)	USPAT	OR	ON	2007/08/27 15:52
S14	152	S11 and ((resin or adhesive or glue) with light)	USPAT	OR	ON	2007/08/27 15:52
S15	152	S14 and (irradiat\$3 or radiat\$3 or photothermal or UV or light or energy)	USPAT	OR	ON	2007/08/27 15:52
S17	76	S15 and ((irradiat\$3 or radiat\$3 or photothermal or UV or light or energy) with resin)	USPAT	OR	ON	2007/08/28 11:09
S18	21348	S10 and ((dic\$3 or cut\$4 or separat\$3) with wafer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 15:56
S19	1372	S18 and ((resin or adhesive or glue) with (light or UV))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 08:04
S20	99	S19 and (photothermal or light adj heat) .	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ОИ	2007/08/27 16:00
S21	1244	S19 and ((photothermal or light adj heat) with conversion layer)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 16:04

S22	962	S21 and (laminat\$4 or coat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR .	ON	2007/08/27 16:05
S23	522	S22 and vacuum	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 16:05
S24	74	S23 and (scribe adj line\$2)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 16:26
S25	180	S23 and (scribe adj line\$2 or street\$)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/27 16:26
S26	1	"7201969"	USPAT	OR	ON	2007/08/28 12:18
S27	0	EP0571649	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 12:32
S28		. "0571649"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	óй ·	2007/08/28 12:45

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S29	11	"4037014"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 12:54
S30	128	"6214520"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 15:30
S31	4	"7201969"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ОИ	2007/08/28 16:58
S32		"6620649"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/29 09:23
S34	2	"200030506"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 15:30
S35	35	"0135457"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 14:14
S39	35	"0135457"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWEN T; IBM_TDB	OR	ON	2007/08/28 14:15

S40	48	"0030506"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO;	OR	ON	2007/08/28 14:15
			DERWEN T; IBM_TDB		,	